

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5131586

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIE GAO	09/21/2017
YANIV HAIM FRISHMAN	09/24/2017
ANAND S. KONANUR	09/27/2017
MANISH A. HIRANANDANI	09/21/2017
ULUN KARACAOGLU	09/25/2017
ATSUO KUWAHARA	09/21/2017
SONGNAN YANG	05/12/2018
RECEIVING PARTY DATA	
Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD.
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15719057
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	request@slwip.com
Correspondent Name:	SCHWEGMAN LUNDBERG & WOESSNER, P.A.
Address Line 1:	P.O. BOX 2938
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402
ATTORNEY DOCKET NUMBER:	1884.081US1
NAME OF SUBMITTER:	CARLEE DAVICH
SIGNATURE:	/Carlee Davich/
DATE SIGNED:	09/10/2018
Total Attachments: 15	

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RECORDATION FORM COVER SHEET
PATENTS ONLY

Atty Ref/Docket No.: (P115757) 1884.081US1

Patent and Trademark Office

To the Director of the U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Jie Gao, Yaniv Haim Frishman, Anand S. Konanur,
Manish A. Hiranandani, Ulun Karacaoglu, Atsuo
Kuwahara, Songnan Yang

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: September 21, 2017, September 24,
2017, September 27, 2017, September 21, 2017,
September 25, 2017, September 21, 2017, May 12, 2018

2. Name and address of receiving party(ies):

Name: Intel Corporation

Street Address: 2200 Mission College Blvd.

City: Santa Clara State: CA Zip: 95054

Country: United States of America

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

Serial No. 15/719,057

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: Mark Bergner

Address:

Swegman Lundberg & Woessner, P.A.
P.O. Box 2938
Minneapolis, Minnesota 55402

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):\$ 0.00

☐ Enclosed

☐ Authorized to be charged to deposit account
190743

8. Please charge any additional fees or credit any over
payments to our Deposit Account No.: 190743

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Mark Bergner/Reg. No. 45,877

Name of Person Signing


Signature

September 6, 2018

Date

Total number of pages including cover sheet: 15

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks
Mail Stop Assignment Recordation Services
P.O. Box 1450
Alexandria, VA 22313-1450

PATENT
REEL: 046823 FRAME: 0783

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

<Jie Gao, Yaniv Haim Frishman, Anand S. Konanur, Manish A. Hiranandani, Ulun Karacaoglu, Atsuo Kuwahara, Songnan Yang>

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SMART BEAMWIDTH ADAPTATION IN WIRELESS HEAD-MOUNTED DISPLAYS

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on September 28, 2017 as

United States of America Application Number 15/719,057
Country or International Office

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute

all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Jie Gao

09/21/2017

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Date Signed

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Date Signed

Manish A. Hiranandani

Date Signed

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Jie Gao

Date Signed

Yaniv Haim Frishman
Yaniv Haim Frishman

Sep. 24th, 2017
Date Signed

Anand S. Konanur

Date Signed

Manish A. Hiranandani

Date Signed

Ulun Karacaoglu

Date Signed

Atsuo Kuwahara

Date Signed

Songnan Yang

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_____ Jie Gao	_____ Date Signed
_____ Yaniv Haim Frishman	_____ Date Signed
_____  Anand S. Konanur	_____ 9/27/2017 Date Signed
_____ Manish A. Hiranandani	_____ Date Signed
_____ Ulun Karacaoglu	_____ Date Signed
_____ Atsuo Kuwahara	_____ Date Signed
_____ Songnan Yang	_____ Date Signed

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Date Signed



Manish A. Hiranandani

09/21/17

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_____ Yaniv Haim Frishman	_____ Date Signed
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_____ Manish A. Hiranandani	_____ Date Signed
 _____ Ulun Karacaoglu	25 Sept 2017 _____ Date Signed
_____ Atsuo Kuwahara	_____ Date Signed
_____ Songnan Yang	_____ Date Signed

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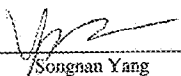
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Manish A. Hiranandani	Date Signed
Ulun Karacaoglu	Date Signed
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 Songnan Yang	2018.5.12 Date Signed